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Dear Colleague:

Over the past decade the NEMI Electronic Manufacturing Technology Roadmaps have been credited by a number of leading industry suppliers with having improved their competitiveness by defining the future needs of their customers.

Under the sponsorship of the National Electronics Manufacturing Initiative (NEMI), a meeting is held every other year to obtain broad participation in the review and update of the Roadmaps. The NEMI Roadmaps coordinate with input from the Roadmaps of IPC, ITRS, OIDA, US Display Consortia, IMAPS, and INSIC. The 2004 Roadmaps will represent a significant enhancement of the 2002 Roadmaps. For the first time the NEMI Roadmaps will represent a global view of the needs of the electronics industry. We particularly encourage participation from the global electronics community in this process. For example, we have established a more formal relationship with the IEEE CPMT society to attract more of their international membership to participate. In addition for the first time the roadmap will address the needs of three additional product sectors: System in Package, Medical Electronics, and Data and Network Communication.

You are cordially invited to participate in this Roadmap process. You can be assured that your input, either at the meeting or in writing to responsible Technology Working Groups or the NEMI Technical Committee will receive serious consideration. The meeting will be held at NEMI Headquarters at the Center for Innovative Technology in Herndon Virginia on June 23, On the evening of June 22 we will hold a banquet celebrating the tenth anniversary of the NEMI Roadmap with speakers from Government and Industry.

Your contributions, both past and present, to this cooperative planning activity are appreciated. I look forward to your participation at this important meeting.

Sincerely

Dr. Nasser Grayeli  
Vice President Technology and Manufacturing  
Director, Assembly Technology Development, Intel Corporation  
Chairman, NEMI Board of Directors